10G SFP+ transceiver MM 10GBase-SR, 850nm, 300m max reach



This 850 nm VCSEL 10 Gigabit SFP+ transceiver is designed to transmit and receive optical data over 50/125 μ m or 62.5/125 μ m multimode optical fiber.

This transceiver accepts 2 LC connectors.

The SFP+ SR module electrical interface is compliant to SFI electrical specifications. The transmitter input and receiver output impedance is 100 Ohms differential. Data lines are internally AC coupled. The module provides differential termination and reduces differential to common mode conversion for quality signal termination and low EMI. SFI typically operates over 200mm of improved FR4 material or up to about 150mm of standard FR4 with one connector.

The transmitter converts 10Gbit/s serial PECL or CML electrical data into serial optical data compliant with the 10GBASE-SR standard. An open collector compatible Transmit Disable (Tx_Dis) is provided. A logic "1," or no connection on this pin will disable the laser from transmitting. A logic "0" on this pin provides normal operation. The transmitter has an internal automatic power control loop (APC) to ensure constant optical power output across supply voltage and temperature variations. An open collector compatible Transmit Fault (TFault) is provided. TX_Fault is a module output contact that when high, indicates that the module transmitter has detected a fault condition related to laser operation or safety. The TX_Fault output contact is an open drain/collector and shall be pulled up to the Vcc_Host in the host with a resistor in the range 4.7-10 k Ω . TX_Disable is a module input contact. When TX_Disable is asserted high or left open, the SFP+ module transmitter output shall be turned off. This contact shall be pulled up to VccT with a 4.7 k Ω to 10 k Ω resistor.

The receiver converts 10Gbit/s serial optical data into serial PECL/CML electrical data. An open collector compatible Loss of Signal is provided. Rx_LOS when high indicates an optical signal level below that specified in the relevant standard. The Rx_LOS contact is an open drain/collector output and shall be pulled up to Vcc_Host in the host with a resistor in the range 4.7-10 k Ω , or with an active termination. Power supply filtering is recommended for both the transmitter and receiver. The Rx_LOS signal is intended as a preliminary indication to the system in which the SFP+ is installed that the received signal strength is below the specified range. Such an indication typically points to non-installed cables, broken cables, or a disabled, failing or a powered off transmitter at the far end of the cable.



Features

- Optical interface compliant to IEEE 802.3ae 10GBASE-SR
- Compliance: MSA SFF-8431, RoHS
- Hot Pluggable
- 850nm VCSEL transmitter, PIN photo-detector
- Maximum link length of 300m on 2000MHz/km MMF
- Operating case temperature: 0 to 70°C
- Low power consumption
- All-metal housing for superior EMI performance
- Advanced firmware allow customer system encryption information to be stored in transceiver
- Cost effective SFP+ solution, enables higher port densities and greater bandwidth

Applications

- 10GBASE-SR at 10.3125Gbps
- 10GBASE-SW at 9.953Gbps
- Other optical links

Operating Range by Fiber Type

FIBER TYPE	MINIMUM MODAL BANDWIDTH AT 850NM (MHZ*KM)	OPERATING RANGE (METERS)
62.5 μm MMF	160	2 - 26
	200	2 - 33
50 μm MMF	400	2 -66
	500	2 - 82
	2000	2 - 300

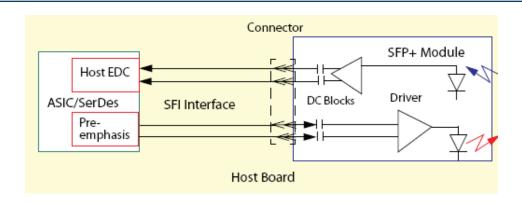
PART NUMBER	DESCRIPTION
SSF-SFP-MM10G	10G SFP+ transceiver MM 10GBase-SR, 850nm, 300m max reach



General Specifications

ITEM	DETAIL
Interface Type	10G
Fiber Type	Multimode
Transceiver Format	SFP
Wavelength	850nm
Tx Distance	300 m
Connectors	LC
Cable Type	Duplex 50/125µm multimode

Interface to Host



Pin Definition

The SFP+ modules are hot-pluggable. Hot pluggable refers to plugging in or unplugging a module while the host board is powered. The SFP+ host connector is a 0.8 mm pitch 20 position right angle improved connector specified by SFF-8083, or stacked connector with equivalent with equivalent electrical performance. Host PCB contact assignment is shown in Figure 2 and contact definitions are given in Table 2. SFP+ module contacts mates with the host in the order of ground, power, followed by signal as illustrated by Figure 3 and the contact sequence order listed in Table 2.

Figure 2: Interface to Host PCB

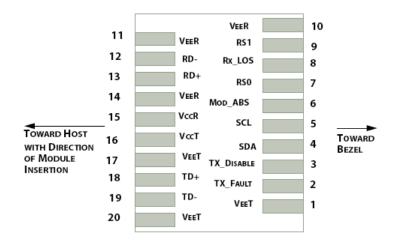
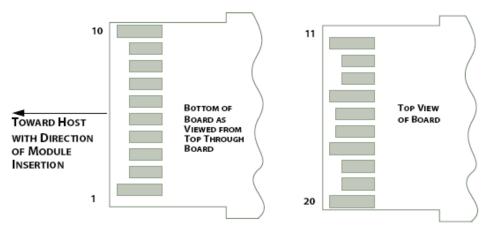




Figure 3: Module Contact Assignment



Pin Definition

CONTACTS	LOGIC	SYMBOL	POWER SEQUENCE ORDER	DESCRIPTION
1		VeeT	1st	Module Transmitter Ground
2	LVTTL-0	TX_Fault	3rd	Module Transmitter Fault
3	LVTTL-I	TX_Disable	3rd	Transmitter Disable; Turns off transmitter laser output
4	LVTTL-I/O	SDA	3rd	2-wire Serial Interface Data Line (Same as MOD-DEF2 in the INF-8074i)
5	LVTTL-I/O	SCL	3rd	2-wire Serial Interface Clock (Same as MOD-DEF1 in the INF-8074i)
6		Mod_ABS	3rd	Module Absent, connected to VeeT or VeeR in the module
7	LVTTL-I	RS0	3rd	Rate Select O, optionally controls SFP+ module receiver. When high input signaling rate > 4.25 GBd and when low input signaling rate ≤ 4.25 GBd
8	LVTTL-0	Rx_LOS	3rd	Receiver Loss of Signal Indications (In FC designated as RX_LOS and in Ethernet designated as Signal Detect)
9	LVTTL-I	RS1	3rd	Rate Select 1, optionally controls SFP+ transmitter . When high input signaling rate > 4.25 GBd and when low input signaling rate ≤ 4.25 GBd
10		VeeR	1st	Module Receiver Ground
11		VeeR	1st	Module Receiver Ground
12	CML-0	RD-	3rd	Receiver Inverted Data Output
13	CML-0	RD+	3rd	Receiver Non-Inverted Data Output
14		VeeR	1st	Module Receiver Ground
15		VccR	2nd	Module Receiver 3.3 V Supply
16		VccT	2nd	Module Transmitter 3.3 V Supply
17		VeeT	1st	Module Transmitter Ground
18	CML-I	TD+	3rd	Transmitter Non-Inverted Data Input
19	CML-I	TD-	3rd	Transmitter Inverted Data Input
20		VeeT	1st	Module Transmitter Ground



Absolute Maximum Ratings

These values represent the damage threshold of the module. Stress in excess of any of the individual Absolute Maximum Ratings can cause immediate catastrophic damage to the module even if all other parameters are within Recommended Operating Conditions.

Table 1 - Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNIT
Power Supply Voltage	VCC	0	+3.6	V
Storage Temperature	Tc	-40	+85	°C
Operating Case Temperature	Tc	-5	+75	°C
Relative Humidity	RH	5	95	%
RX Input Average Power	Pmax	-	0	dBm

Recommended Operating Conditions

Recommended Operating Environment specifies parameters for which the electrical and optical characteristics hold unless otherwise noted.

Table 2 - Recommended Operating Conditions

PARAMETER	SYMBOL	MIN	TYPICAL	MAX	UNIT
Power Supply Voltage	VCC	3.135	3.300	3.465	V
Operating Case Temperature	T _c	0	25	70	°C



Optical and Electrical Characteristics

The following optical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

PARAMETER	SYMBOL	MIN	TYPICAL	MAX	UNIT	NOTES
		TRA	NSMITTER			
Center Wavelength	λt	840	850	860	nm	
RMS spectral width	Pm	-	-	Note 1	nm	
Average Optical Power	Pavg	-6.5	-	-1	dBm	2
Extinction Ratio	ER	3.5	-	-	dB	3
Transmitter Dispersion Penalty	TDP	-	-	3.9	dB	
Relative Intensity Noise	Rin	-	-	-128	dB/Hz	12dB reflection
Optical Return Loss Tolerance		-	12	dB		
		R	ECEIVER			
Center Wavelength	λr	840	850	860	nm	
Receiver Sensitivity	Psens	-	-	-11.1	dBm	4
Stressed Sensitivity in OMA	-	-	-7.5	dBm	4	3
Los function	Los	-30	-	-12	dBm	
Overload	Pin	-	-	-1.0	dBm	4
Receiver Reflectance	-	-	-12	dB		

Notes:

- 1. Trade-offs are available between spectral width, center wavelength and minimum OMA, as shown in table 6.
- 2. The optical power is launched into MMF
- 3. Measured with a PRBS 231-1 test pattern @10.3125Gbps
- 4. Measured with a PRBS 231-1 test pattern @10.3125Gbps,BER≤10-12.

Optical Characteristics (Minimum 10GBASE-SR OMA as a Function of Wavelength and Spectral Width)

CENTER		RM	S SPECTR						
WAVELENGTH (NM)	UP TO 0.05	0.05 TO 0.1	0.1 TO 0.15	0.15 TO 0.2	0.2 TO 0.25	0.25 TO 0.3	0.3 TO 0.35	0.35 TO 0.4	0.4 TO 0.45
840 to 842	-4.2	-4.2	-4.1	-4.1	-3.9	-3.8	-3.5	-3.2	-2.8
842 to 844	-4.2	-4.2	-4.2	-4.1	-3.9	-3.8	-3.6	-3.3	-2.9
844 to 846	-4.2	-4.2	-4.2	-4.1	-4.0	-3.8	-3.6	-3.3	-2.9
846 to 848	-4.3	-4.2	-4.2	-4.1	-4.0	-3.8	-3.6	-3.3	-2.9
848 to 850	-4.3	-4.2	-4.2	-4.1	-4.0	-3.8	-3.6	-3.3	-3.0
850 to 852	-4.3	-4.2	-4.2	-4.1	-4.0	-3.8	-3.6	-3.4	-3.0
852 to 854	-4.3	-4.2	-4.2	-4.1	-4.0	-3.9	-3.7	-3.4	-3.1
854 to 856	-4.3	-4.3	-4.2	-4.1	-4.0	-3.9	-3.7	-3.4	-3.1
856 to 858	-4.3	-4.3	-4.2	-4.1	-4.0	-3.9	-3.7	-3.5	-3.1
858 to 860	-4.3	-4.3	-4.2	-4.2	-4.1	-3.9	-3.7	-3.5	-3.2



Digital Diagnostic Functions

The following digital diagnostic characteristics are defined over the Recommended Operating Environment unless otherwise specified. It is compliant to SFF8472 Rev9.2 with internal calibration mode. For external calibration mode please contact our sales stuff.

PARAMETER	SYMBOL	MIN	MAX	UNIT	NOTES
Temperature monitor absolute error	DMI_Temp	-3	+3	degC	Over operating temp
Laser power monitor absolute error	DMI_TX	-3	+3	dB	
RX power monitor absolute error	DMI_RX	-3	+3	dB	-3dBm to -12dBm range
Supply voltage monitor absolute error	DMI_VCC	-0.08	+0.08	V	Full operating range
Bias current monitor	DMI_Ibias	-10%	10%	mA	

Electrical Characteristics

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

PARAMETER	SYMBOL	MIN	TYPICAL	MAX	UNIT	NOTES
Data Rate		-	10.3125	-	Gbps	
Power Consumption		-	600	800	mW	
	TR	RANSMITT	ER			
Single Ended Output Voltage Tolerance		-0.3	-	4.0	V	
C common mode voltage tolerance		15	-	-	mV	
Tx Input Diff Voltage	VI	180		1200	mV	
Tx Fault	VoL	-0.3		0.4	V	At 0.7mA
Data Dependent Input Jitter	DDJ			0.10	UI	
Data Input Total Jitter	TJ			0.28	UI	
		RECEIVER	?			
Single Ended Output Voltage Tolerance		-0.3	-	4.0	V	
Rx Output Diff Voltage	Vo	300		850	mV	
Rx Output Rise and Fall Time	Tr/Tf	30			ps	20% to 80%
Total Jitter	TJ			0.70	UI	
Deterministic Jitter	DJ			0.42	UI	



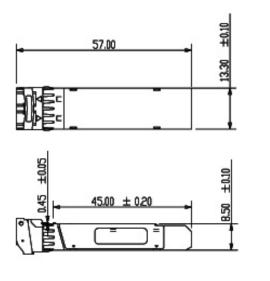
Control and Status I/O Timing Characteristics

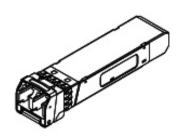
Timing characteristics of control and status I/O are included below (Table 8), which is also defined in SFF-8431.

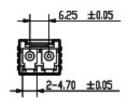
PARAMETER	SYMBOL	MIN	MAX	UNIT	CONDITIONS
TX_Disable assert time	t_of		100	μs	Rising edge of TX_Disable to fall of output signal below 10% of nominal
TX_Disable negate time	t_on		2	ms	Falling edge of TX_Disable to rise of output signal above 90% of nominal. This only applies in normal operation, not during start up or fault recovery
Time To Initialize 2-wire interface	t_2w_start_up		300	ms	From power on or hot plug after the supply meeting Table 8
Time to initialize	t_start_up		300	ms	From power supplies meeting Table 8 or hot plug or TX disable negated during power up, or TX_Fault recovery, until non-cooled power level I part (or non-cooled power level II part already enabled at power level II for TX_Fault recovery) is fully operational.
Time to initialize cooled module	t_start_up_ cooled		90	s	From power supplies meeting Table 8 or hot plug, or TX disable negated during power up, or TX_Fault recovery, until cooled power level I part (or cooled power level II part during fault recovery) is fully operational.
Time to Power Up to Level II	t_power_level2		300	ms	From falling edge of stop bit enabling power level II until non-cooled module is fully operational
Time to Power Down from Level II	t_power_down		300	ms	From falling edge of stop bit disabling power level II until module is within power level I requirements
TX_Fault assert	TX_Fault_on		1	ms	From occurrence of fault to assertion of TX_Fault
TX_Fault assert for cooled module	TX_Fault_on_ cooled		50	ms	From occurrence of fault to assertion of TX_Fault
TX_Fault Reset	t_reset	10		μs	Time TX_Disable must be held high to reset TX_Fault
RS0, RS1 rate select timing for FC	t_RS0_FC, RS1_FC		500	μs	From assertion till stable output
RS0, RS1 rate select timing non FC	t_RS0, t_RS1		10	ms	From assertion till stable output
RX_LOS assert delay	t_los_on		100	μs	From occurrence of loss of signal to assertion of Rx_LOS
Rx_LOS negate delay	t_los_off		100	μs	From occurence of presence of signal to negation of Rx_LOS



Mechanical Dimensions







ESD

This transceiver is specified as ESD threshold 2kV for all electrical input pins, tested per MIL-STD-883, Method 3015.4 / JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

Laser Safety

This is a Class 1 Laser Product according to IEC 60825-1:1993:+A1:1997+A2:2001. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (July 26, 2001)

Ordering Information

PART NUMBER	PRODUCT DESCRIPTION
SSF-SFP-MM10G	10G SFP+ transceiver MM 10GBase-SR, 850nm, 300m max reach